

November 1996 Revised May 2003

NC7SZ384

TinyLogic® UHS 1-Bit Low Power Bus Switch

General Description

The NC7SZ384 provides 1-bit of ultra high-speed CMOS TTL-compatible bus switch. The low On Resistance of the switch allows inputs to be connected to outputs with minimal propagation delay and without generating additional ground bounce noise. The device is organized as a 1-bit switch with a bus enable $(\overline{\text{OE}})$ signal. When $\overline{\text{OE}}$ is LOW, the switch is on and Port A is connected to Port B. When $\overline{\text{OE}}$ is HIGH, the switch is open and a high-impedance state exists between the two ports.

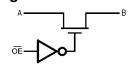
Features

- Space saving SOT23 or SC70 5-lead package
- Ultra small MicroPak™ leadless package
- \blacksquare 5 Ω switch connection between two ports
- Minimal propagation delay through the switch
- Low I_{CC}
- Zero bounce in flow-through mode
- Control inputs compatible with TTL level

Ordering Code:

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
NC7SZ384M5X	MA05B	8Z84	5-Lead SOT23, JEDEC MO-178, 1.6mm	3k Units on Tape and Reel
NC7SZ384P5X	MAA05A	Z84	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3k Units on Tape and Reel
NC7SZ384L6X	MAC06A	C3	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel

Logic Diagram



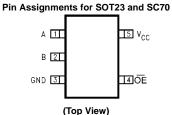
Pin Description

Pin Name	Description
ŌĒ	Bus Switch Enable
Α	Bus A
В	Bus B
NC	No Connect

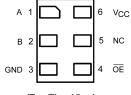
Truth Table

OE	B _O	Function
L	A _O	Connect
Н	HIGH-Z State	Disconnect

Connection Diagrams



Pad Assignments for MicroPak



(Top Thru View)

 $\label{eq:total_cond} \mbox{TinyLogic@ is a registered trademark of Fairchild Semiconductor Corporation.} \\ \mbox{MicroPak}^{\mbox{\tiny TM}} \mbox{ is a trademark of Fairchild Semiconductor Corporation.} \\$

Supply Voltage (V_{CC}) -0.5V to +7.0V CONDITIONS (Note 3)

DC Switch Voltage (V_S) -0.5V to +7.0V Power Supply Operating (V_{CC}) 4.0V to 5.5V

DC Input Voltage (V_{IN}) (Note 2) -0.5V to +7.0V Input Voltage (V_{IN}) 0V to 5.5V

DC Input Diode Current Output Voltage (V_{OUT}) 0V to 5.5V

 $(I_{IK}) V_{IN} < 0V$ —50 mA Input Rise and Fall Time $(t_r, \, t_f)$

DC Output (I_{OUT}) Sink Current 128 mA Switch Control Input 0 ns/V to 5 ns DC V_{CC}/GND Current Switch I/O 0 ns/V to DC

 (I_{CC}/I_{GND}) ±100 mA Operating Temperature (T_A) -40°C to +85°C

Storage Temperature Range Thermal Resistance (θ_{JA})

(T_{STG}) -65°C to +150°C SOT23-5 300°C/W

Junction Temperature SC70-5 425°C/W

under Bias (T_J) +150°C Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical

(Soldering, 10 Seconds)
+260°C

Characteristics tables are not guaranteed at the absolute maximum ratings.
The "Recommended Operating Conditions" table will define the conditions

Power Dissipation (P_D) @ +85°C for actual device operation.

SOT23-5
SC70-5
200 mW
Note 2: The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.
Note 3: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	V _{CC}	$T_A =$	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions	
Cymbol	r arameter	(V)	V) Min Typ Max		Oilles	oonamone		
V _{IK}	Clamp Diode Voltage	4.5			-1.2	-V	I _{IN} = -18 mA	
V _{IH}	HIGH Level Input Voltage	4.5-5.5	2.0			V		
V _{IL}	LOW Level Input Voltage	4.5-5.5			0.8	V		
I _{IN}	Input Leakage Current	5.5			±1.0	μΑ	$0 \le V_{IN} \le 5.5V$	
I _{OFF}	"OFF" Leakage Current	5.5			±10.0	μΑ	0 ≤ A, B ≤ V _{CC}	
R _{ON}	Switch On Resistance	4.5		3	7	Ω	V _{IN} = 0V, I _{IN} = 64 mA	
	(Note 4)	4.5		3	7	Ω	V _{IN} = 0V, I _{IN} = 30 mA	
		4.5		6	15	Ω	V _{IN} = 2.4V, I _{IN} = 15 mA	
		4.0		10	20	Ω	V _{IN} = 2.4V, I _{IN} = 15 mA	
I _{CC}	Quiescent Supply Current	5.5			10	μΑ	V _{IN} = V _{CC} or GND	
							I _O = 0	
ΔI _{CC}	Increase in I _{CC} per Input (Note 5)	5.5		0.9	2.5	mA	$V_{IN} = 3.4V$, $I_O = 0$, Control Input only	

Note 4: Measured by the voltage drop between A and B pins at the indicated current through the switch. On Resistance is determined by the lower of the voltages on the two (A or B) pins.

Note 5: Per TTL driven input ($V_{IN} = 3.4V$, control input only). A and B pins do not contribute to I_{CC} .

AC Electrical Characteristics

			T _A :	$T_A = -40^{\circ}C$ to $+85^{\circ}C$,				
Symbol	Parameter	V _{CC}	$ extsf{C}_{ extsf{L}} = extsf{50} extsf{ pF, RU} = extsf{RD} = extsf{500} \Omega$		Units	Conditions	Figure	
		(V)	Min	Typ (Note 6)	Max			Number
t _{PHL} ,	Propagation Delay Bus to Bus	4.0-5.5			0.25	ns	V _I = OPEN	Figures
t _{PLH}	(Note 7)							1, 2
t _{PZL} ,	Output Enable Time	4.5-5.5	1.0	2.5	5.0	ns	V _I = 7V for t _{PZL}	Figures
t _{PZH}		4.0	1.0		5.5	ns	$V_I = OPEN \text{ for } t_{PZH}$	1, 2
t _{PLZ} ,	Output Disable Time	4.5-5.5	1.0	2.5	5.0	ns	$V_I = 7V$ for t_{PLZ}	Figures
t _{PHZ}		4.0	1.0		5.5	ns	$V_I = OPEN \text{ for } t_{PHZ}$	1, 2

Capacitance (Note 8)

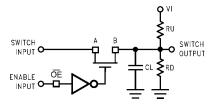
Symbol	Parameter	Тур	Max	Units	Conditions
C _{IN}	Control Pin Input Capacitance	2	6	pF	$V_{CC} = 5.0V$
C _{I/O}	Input/Output Capacitance	4.5	10	pF	V_{CC} , $\overline{BE} = 5.0V$

Note 6: All typical values are $V_{CC} = 5.0V$, $T_A = 25$ °C.

Note 7: This parameter is guaranteed by design but is not tested. The bus switch contributes no propagation delay other than the RC delay of the typical On Resistance of the switch and the 50 pF load capacitance, when driven by an ideal voltage source (zero output impedance).

Note 8: $T_A = 25^{\circ}C$, f = 1 MHz.

AC Loading and Waveforms



Input driven by 50Ω source terminated in 50Ω C_L includes load and stray capacitance

Input PRR = 1.0 MHz; t_W = 500 ns

FIGURE 1. AC Test Circuit

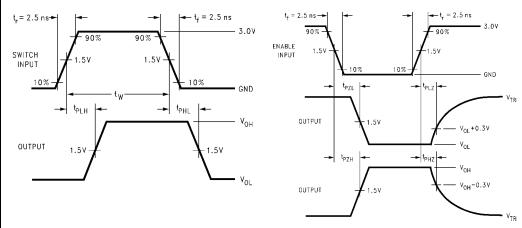
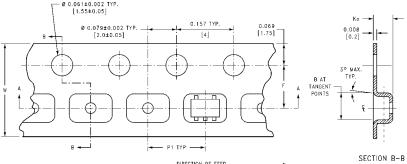


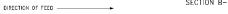
FIGURE 2. AC Waveforms

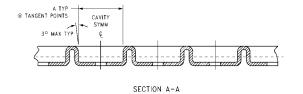
Tape and Reel Specification TAPE FORMAT for SOT23 and SC70

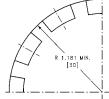
THE ET ORIGINATION COTES AND COTS								
Package	Таре	Number	Cavity	Cover Tape				
Designator	Section	Cavities	Status	Status				
	Leader (Start End)	125 (typ)	Empty	Sealed				
M5X, P5X	Carrier	3000	Filled	Sealed				
	Trailer (Hub End)	75 (typ)	Empty	Sealed				

TAPE DIMENSIONS inches (millimeters)





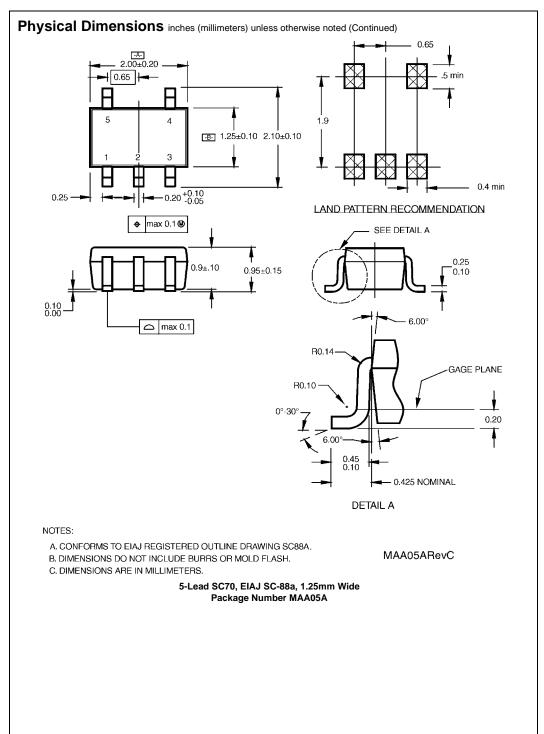




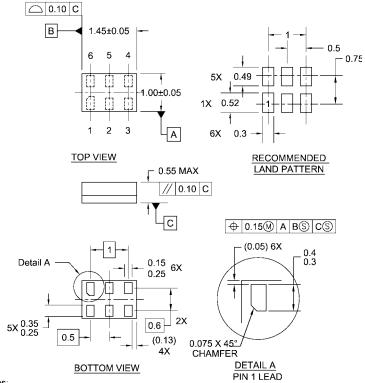
				,
BEND	RADIUS	NOT	TO	SCALE

Package	Tape Size	DIM A	DIM B	DIM F	DIM K _o	DIM P1	DIM W
SC70-5	8 mm	0.093	0.096	0.138 ± 0.004	0.053 ± 0.004	0.157	0.315 ± 0.004
		(2.35)	(2.45)	(3.5 ± 0.10)	(1.35 ± 0.10)	(4)	(8 ± 0.1)
SOT23-5	8 mm	0.130	0.130	0.138 ± 0.002	0.055 ± 0.004	0.157	0.315 ± 0.012
		(3.3)	(3.3)	(3.5 ± 0.05)	(1.4 ± 0.11)	(4)	(8 ± 0.3)

Tape and Reel Specification (Continued) TAPE FORMAT for MicroPak Package Tape Number Cavity Cover Tape Designator Section Cavities Status Status Leader (Start End) 125 (typ) Empty Sealed L6X Carrier 5000 Filled Sealed Trailer (Hub End) 75 (typ) **Empty** Sealed 2.00-1.75±0.10 В 8.00 ^{+0.30} -0.10 3.50±0.05 1.15±0.05 В ∟ø 0.50 ±0.05 SECTION B-B SCALE:10X 0.254±0.020 ┌ 0.70±0.05 SECTION A-A SCALE:10X **REEL DIMENSIONS** inches (millimeters) TAPE SLOT DETAIL X DETAIL X SCALE: 3X W1 W2 W3 В С D Ν Tape Α Size W1 + 0.078/-0.039 0.331 + 0.059/-0.000 0.567 7.0 0.059 0.512 0.795 2.165 8 mm (177.8)(1.50)(13.00)(20.20)(55.00)(8.40 + 1.50 / -0.00)(W1 + 2.00/-1.00)(14.40)



Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Notes:

- 1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

6-Lead MicroPak, 1.0mm Wide Package Number MAC06A

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